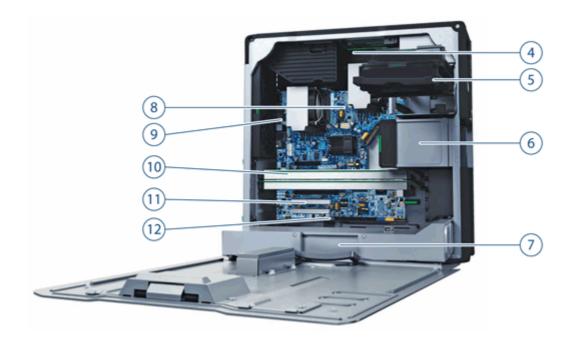
Overview

HP recommends Windows Vista®
Business



- 1. Power Button
- 2. 2 External 5.25" Bays
- 3. Front I/O: 3 USB 2.0, 1 IEEE 1394a (optional card required), Headphone, Microphone

Overview



- 4. 6 DIMM Slots for DDR3 ECC Memory
- 5. 2 Internal 3.5" Bays
- 6. 2 External 5.25" Bays
- 7. 650W, 85% efficient Power Supply
- 8. 2 Quad Core Intel 5500 Series Processors

- Rear I/O: 6 USB 2.0, PS/2 keyboard/mouse
 RJ-45 to Integrated Gigabit LAN
 Audio Line In, 1 Audio Line Out, 1 Microphone In
- 10. 2 PCle x16 Gen2 Slots
- 11.. 1 PCle x4 Gen2, 1 PCle x4 Gen1, 2 PCl Slots
- 12 3 Internal USB 2.0 ports

_	
Form	Factor

Compatible Operating Systems

Minitower

Genuine Windows Vista® Business 64-bit*

Genuine Windows Vista® Business 32-bit*

Genuine Windows Vista® 64-bit downgrade to Genuine Microsoft® Windows® XP Professional 64-bit (expected available until August 2009)**

Genuine Windows Vista® 32-bit downgrade to Genuine Microsoft® Windows® XP Professional 32-bit (expected available until August 2009)**

HP Linux Installer Kit for Linux (includes drivers for both 32-bit & 64-bit OS versions of Red Hat Enterprise Linux WS4 and WS5 - see: http://www.hp.com/workstations/software/linux)

For detailed OS/hardware support information for Linux, see:

http://www.hp.com/support/linux hardware matrix

*Certain Windows Vista product features require advanced or additional hardware. See http://www.microsoft.com/windowsvista/getready/hardwareregs.mspx and

http://www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit http://www.windowsvista.com/upgradeadvisor.

**Windows Vista Business disk may also be included for future upgrade if desired. To qualify for this downgrade an end user must be a business (including governmental or educational institutions) and is



Overview

Overview	
	expected to order at least 25 customer systems with the same custom image.
Available Processors	Intel® Xeon® Processor X5570 QC 2.93 GHz, 95W, 8M cache, 6.40GT/s QPI, DDR3 1333MHz, HT,
	Turbo Intel Xeon Processor X5560 QC 2.80 GHz, 95W, 8M cache, 6.40GT/s QPI, DDR3 1333MHz, HT,
	Turbo Intel Xeon Processor X5550 QC 2.66 GHz, 95W, 8M cache, 6.40GT/s QPI, DDR3 1333MHz, HT,
	Turbo Intel Xeon Processor E5540 QC 2.53 GHz, 80W, 8M cache, 5.86GT/s QPI, DDR3 1066MHz, HT,
	Turbo
	Intel Xeon Processor E5530 QC 2.40 GHz, 80W, 8M cache, 5.86GT/s QPI, DDR3 1066MHz, HT, Turbo
	Intel Xeon Processor E5520 QC 2.26 GHz, 80W, 8M cache, 5.86GT/s QPI, DDR3 1066MHz, HT, Turbo
	Intel Xeon Processor E5506 QC 2.13 GHz, 80W, 4M cache, 4.80GT/s QPI, DDR3 800MHz Intel Xeon Processor E5504 QC 2.00 GHz, 80W, 4M cache, 4.80GT/s QPI, DDR3 800MHz
Available Processor Disclaimers	When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor_number/ for details.
	Quad-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies.
	64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processor will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: http://www.intel.com/info/em64t for more information.
	Intel's numbering is not a measurement of higher performance.
Additional Details	Intel® Nehalem Architecture Up to 6.40GT/s QPI support
	• 3-channel 800/1066/1333 MHz DDR3 memory* subsystem
	 Up to 24 GB Memory capacity with 6 DIMM slots and 4 GB DIMMs PCI Express I/O and PCIe x16 Gen2 graphics
	Integrated Broadcom 5764 Gigabit LAN on Motherboard (LOM)
	 6 channels of Serial ATA (SATA) 3.0 Gb/s natively supported internally SATA RAID** 0, 1, 5, and 10 support standard on motherboard
	 SAS RAID 0, 1, and 10 supported using the LSI 3041E PCle controller
	SATA optical drives High Definition integrated guide with integral angular.
	 High Definition integrated audio with internal speaker 650W 85% efficient power supply
	 ENERGY STAR® qualification and energy-saving features available on selected configurations (No supported by Linux) Protected by HP Services, including a 3 years parts, 3 years labor, and 3 years onsite service
	(3/3/3) standard warranty. Terms and conditions vary by country. Certain restrictions and exclusions apply.



*Each processor supports up to 3 channels of DDR3 memory. To realize full performance at least 1 DIMM must be inserted into each channel. To get full 6 channel support, 2 processors MUST be installed.

Overview

	**SATA hardware RAID is not supported	on Linux systems. The Linux kernel, with built-in software RAID,			
		ormance. It is a good alternative to hardware-based RAID. Please			
	visit http://h20000.www2.hp.com/bc/de	ocs/support/SupportManual/c00060684/c00060684.pdf for			
	RAID capabilities with Linux.				
Form Factor	Rackable Minitower				
Color	Black/Silver				
I/O Slots (see system	• 2 PCI Express Gen2 x16 slots (full	-length, full-height)			
board section for more	• 1 PCI Express Gen2 x8 slot - with	x8 connectors (full-length, full-height)			
details)		x8 connectors (full-length, full-height)			
	• 2 PCI 32bit/33MHz slot, (full-leng				
		ended, allowing a PCIe x16 card to be seated in the slot.			
Bays (see storage section	Total Bays = 4				
for more details)					
Internal Bays	2 internal 3.5" bays (with acoustic damp	ening rail assemblies)			
External Bays	2 external 5.25" bays				
	(3rd & 4th HDDs occupy one external bo	•			
Front I/O	3 USB 2.0, 1 Headphone Out, 1 Microp				
	(For front 1394a port to function, option	nal 1394 card must be installed.)			
Rear I/O	6 USB 2.0				
1 RJ-45 to integrated Gigabit LAN					
	2 legacy PS/2				
		crophone In; audio ports can be retasked to function as line in,			
	line out, microphone, or headphone.	sand adapter			
Internal USB	Serial supported with optional rear bulkl 3 USB 2.0 headers	leda daapier.			
		4)			
D x H)	17.5 x 6.5 x 17.3 in (44.51 x 16.53 x 4	<u> </u>			
Weight	Exact weights depend upon configuratio	n			
	Minimum config – 33.0 lb (15.0 kg)				
	Typical config – 37.4 lb (16.9 kg)				
	Maximum config – 43.3 lb (19.6 kg)	02 / 1 .)			
т ,	(Maximum shipping weight – 52.0 lb / 2				
Temperature		5°F (5° to 35°C)			
1.1 10.		40° F (–40° to 60° C)			
Humidity	Operating: 8% to 85				
	Non-operating 8% to 90				
Maximum Altitude (non-		eet; 3,000 m			
pressurized)		eet; 9,100 m			
Power Supply		de-ranging, active Power Factor Correction, with tool-free &			
	cable-free connection				
Interfaces Supported	,	erial-ATA connectors on the motherboard, 4 channels are eSATA			
	configurable for use with eSATA CTO/A				
	SAS interface supported with optional LS	·			
	1 Floppy interface (1 Floppy connector),	USB 2.0			
Hard Drive Controllers	SATA and SAS controllers				
Supported	<u> </u>				



Supported Components

Processors

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
Quad-Core Intel Xeon Processor 5500 Series with Intel®	® 64 Architectu	re		
Intel Xeon X5570, 2.93GHz, 8MB cache, 1333MHz Memory, 6.40 GT/s QPI, 95W	Υ	Υ	NF153AA	
Intel Xeon X5560, 2.80GHz, 8MB cache, 1333MHz Memory, 6.40 GT/s QPI, 95W	Υ	Υ	NF152AA	
Intel Xeon X5550, 2.66GHz, 8MB cache, 1333MHz Memory, 6.40 GT/s QPI, 95W	Υ	Υ	NF151AA	
Intel Xeon E5540, 2.53GHz, 8MB cache, 1066MHz Memory, 5.86 GT/s QPI, 80W	Υ	Υ	NF150AA	
Intel Xeon E5530, 2.40GHz, 8MB cache, 1066MHz Memory, 5.86 GT/s QPI, 80W	Υ	Υ	NF149AA	
Intel Xeon E5520, 2.26GHz, 8MB cache, 1066MHz Memory, 5.86 GT/s QPI, 80W	Υ	Υ	NF148AA	
Intel Xeon E5506, 2.13GHz, 4MB cache, 800MHz Memory, 4.80 GT/s QPI, 80W	Υ	Υ	NF147AA	
Intel Xeon E5504, 2.00GHz, 4MB cache, 800MHz Memory, 4.80 GT/s QPI, 80W	Υ	Υ	NF146AA	

NOTE 1: When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor_number/ for details.

Quad-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies.

64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processor will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: http://www.intel.com/info/em64t for more information.

Intel's numbering is not a measurement of higher performance.

Supported Components

Sub-Section Description/Notes

For hard drives, 1 GB = 1 billion bytes; TB = 1 trillion bytes. Actual formatted capacity is less. Up to 12 GB of hard drive (or system disk) is reserved for the system recovery software (XP and XP Pro). Up to 3 GB of system disk is reserved for system recovery software (Vista).

SAS Hard Drives		Option			
		Factory Configured	Option Kit	Kit Part Number	Support Notes
	HP SAS (Serial Attached SCSI) Hard Drives for HP Workst	ations			
	146 GB 15K rpm SAS 3.0 Gb/s 3.5" Hard Drive	Υ	Υ	EA330AA	
	300 GB 15K rpm SAS 3.0 Gb/s 3.5" Hard Drive	Υ	Υ	EM174AA	
	450 GB 15K rpm SAS 3.0 Gb/s 3.5" Hard Drive	Υ	Υ	FM803AA	
	Sub-Section Description/Notes				
	Up to 3 of the following 3.5" SATA and 3.5" 15K SAS drive (SFF) 10K SATA drives are allowed. (2.5" SFF drives cannot be mixed with 3.5" drives)	es, or up to 4 c	of the 2.5"	small form f	actor
SATA Hard Drives	SATA (Serial ATA) Hard Drives for HP Workstations				
	160 GB 7,200 rpm SATA 3.0 Gb/s with NCQ 3.5" Hard Drive	Υ	Υ	PV944A	
	250 GB 7,200 rpm SATA 3.0 Gb/s with NCQ 3.5" Hard Drive	Υ	Υ	EA788AA	
	320 GB 7,200 rpm SATA 3.0 Gb/s with NCQ 3.5" Hard Drive	Υ	Υ	FH963AA	
	500 GB 7,200 rpm SATA 3.0 Gb/s with NCQ 3.5" Hard Drive	Υ	Υ	PV943A	
	1 TB 7,200 rpm SATA 3.0 Gb/s with NCQ 3.5" Hard Drive	Υ	Υ	GE262AA	
	160 GB 10K rpm SATA with NCQ 2.5" Hard Drive	Υ	Υ	EW222AA	
	300 GB 10K rpm SATA with NCQ 2.5" Hard Drive	Υ	Υ	FM802AA	
	NOTE: SAS Controller, not integrated, is required)				

For hard drives, 1 GB = 1 billion bytes; TB = 1 trillion bytes. Actual formatted capacity is less. Up to 12 GB of hard drive (or system disk) is reserved for the system recovery software (XP and XP Pro). Up to 3 GB of system disk is reserved for system recovery software (Vista).



Supported Components

Hard Drive Controllers		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated SATA 3.0 Gb/s Controller				
	Integrated SATA 3.0 Gb/s Controller, RAID 0, 1, 10, 5 supported	Υ	Ν		
	Factory integrated RAID on motherboard for SATA	A drives			
	RAID 0 Configuration - Striped Array	Υ	Ν		See note 1
	RAID 1 Configuration - Mirrored Array	Υ	Ν		See note 1
	LSI 3041E 4-Port SAS 3.0 Gb/s RAID Card				
	LSI 3041E 4-Port SAS 3.0 Gb/s RAID Card	Υ	Υ	EH417AA	
	LSI MegaRAID® SAS 8888ELP Host Bus Adapter ((HBA)			
	LSI 8888ELP 8-port SAS HW RAID Card	Ν	Υ	GE258AA	
	All RAID arrays must be less than 2 TB in size				

NOTE 1: Requires 2 identical hard drives (speeds, capacity, interface). RAID 1 does not support a 3rd HDD. No Linux support for SATA RAID.

NOTE: Specific user-configured hardware SAS RAID configurations are supported on this system with Linux. Please visit: http://www.hp.com/support/linux hardware matrix for details.

LSI RAID Definitions:

SATA hardware RAID is not supported on Linux systems. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit http://h20000.www2.hp.com/bc/docs/support/SupportManual/c00060684/c00060684.pdf for RAID capabilities with Linux.

IS: Striping of 2 or more HDDs into a single logical volume

IM: Mirroring of 2 HDDs into a single logical volume

IME: Mirroring of 3 or more HDDs into a single logical volume

NOTE: Specific user-configured hardware SAS RAID configurations are supported on this Linux system. Please visit: http://www.hp.com/support/linux hardware matrix for details



Supported Components

Graphics		Factory Configured	Option Kit	Option Kit Part Number	Support Notes	Supported Multi Mixed
	Professional 2D	J			• •	
	NVIDIA Quadro NVS 295 256MB PCIe Graphics Card	Υ	Υ	FY943AA	2nd card must be NVS 450 or NVS 295	2 X
	NVIDIA Quadro NVS 450 512 MB PCIe Graphics Card	Y	Υ	FH519AA	2nd card must be NVS 450 or NVS 295	2 X
	NVIDIA Quadro NVS 290 256 MB PCIe Graphics Card with 'DMS-59 to Dual DVI cable' included - for Workstations	Ν	Y	GN502AA	1 or 2 of these cards are supported - 2nd card must be NVS 290	2
	Entry 3D					
	NVIDIA Quadro FX 380 256MB PCIe Graphics Card	Y	Υ	NB769AA		2
	ATI FirePro V3700 256MB PCle Graphics Card	Υ	Υ	FY944AA		2
	NVIDIA Quadro FX 580 512MB PCle Graphics Card	Υ	Υ	FY945AA		2
	Mid-range 3D					
	NVIDIA Quadro FX 1800 768MB PCle Graphics Card	Υ	Υ	FY946AA		2
	ATI FirePro V5700 512MB PCle Graphics Card	Υ	Υ	FY947AA		2
	High End 3D					
	NVIDIA Quadro FX 3800 1.0GB PCle Graphics Card (AVAILABLE JUNE 2009)	Υ	Υ	FY949AA		1
	ATI FirePro V7750 1.0GB PCle Graphics Card	Υ	Υ	FY948AA		1
	NVIDIA Quadro FX 4800 1.5GB PCIe Graphics Card	Υ	Υ	FQ138AA		1
	NVIDIA Quadro CX - The Accelerator for Creative Suite 4	Υ	Ν			1



Supported Components

Memory

СТО	Support Notes
PC3-10600 DDR3-1333 ECC Unbuffered DIMMs CTO	
1GB (1x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU	
2GB (2x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU	
3GB (3x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU	
4GB (2x2GB) DDR3-1333 ECC Unbuffered RAM 1-CPU	
6GB (3x2GB) DDR3-1333 ECC Unbuffered RAM 1-CPU	
8GB (2x4GB) DDR3-1333 ECC Unbuffered RAM 1-CPU	
12GB (3x4GB) DDR3-1333 ECC Unbuffered RAM 1-CPU	
2GB (2x1GB) DDR3-1333 ECC Unbuffered RAM 2-CPU	Both processor sockets must be populated.
4GB (4x1GB) DDR3-1333 ECC Unbuffered RAM 2-CPU	Both processor sockets must be populated.
4GB (2x2GB) DDR3-1333 ECC Unbuffered RAM 2-CPU	Both processor sockets must be populated.
6GB (6x1GB) DDR3-1333 ECC Unbuffered RAM 2-CPU	Both processor sockets must be populated.
8GB (4x2GB) DDR3-1333 ECC Unbuffered RAM 2-CPU	Both processor sockets must be populated.
8GB (2x4GB) DDR3-1333 ECC Unbuffered RAM 2-CPU	Both processor sockets must be populated.
12GB (6x2GB) DDR3-1333 ECC Unbuffered RAM 2-CPU	Both processor sockets must be populated.
16GB (4x4GB) DDR3-1333 ECC Unbuffered RAM 2-CPU	Both processor sockets must be populated.
24GB (6x4GB) DDR3-1333 ECC Unbuffered RAM 2-CPU	Both processor sockets must be populated.

Sub-Section Description/Notes

NOTE: The Z600 has a three-channel memory architecture. Three channels are associated with each processor. For optimal performance, populate a DIMM in each channel.

AMO

PC3-10600 DDR3-1333 ECC Unbuffered DIMMs AMO

1GB (1x1GB) DDR3-1333 ECC Unbuffered RAM 2GB (1x2GB) DDR3-1333 ECC Unbuffered RAM 4GB (1x4GB) DDR3-1333 ECC Unbuffered RAM

NOTE: Although all of these memory configurations incorporate 1333MHz memory modules, the speed at which they operate is dependent upon the processor.

Supported Components

Multimedia and Audio Devices		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated Intel/Realtek HD ALC262 Audio	Υ	Ν		
	HP Thin USB Powered Speakers	Υ	Υ	KK912AA	
	Creative X-Fi Titanium PCIe Audio Card	Υ	Υ	NH222AA	

Optical and Removable Storage		Factory Configured	Option Kit	Option Kit Part Number Support Notes
	HP 16X DVD-ROM SATA Drive	Υ	Υ	AR629AA See note 1
	HP 16X DVD+-RW SuperMulti SATA Drive	Υ	Υ	AR630AA
	HP Slot Load DVD+/-RW Drive	Υ	Ν	
	HP Blu-ray Writer	Υ	Υ	AR482AA
	1.44 MB Diskette Drive (1 only)	Υ	Υ	NK360AA
	HP 22-in-1 Media Card Reader Kit (Workstations)	Υ	Υ	NK361AA
	HP DX115 Removable Drive Enclosure			
	HP DX115 Carrier with 160GB SATA HDD	Ν	Υ	FZ577AA
	HP DX115 Removable HDD Frame/Carrier	Ν	Υ	FX576AA
	HP DX115 Removable HDD Carrier	Ν	Υ	NB792AA

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

NOTE 1: Not supported as a 2nd Optical Drive.

Controller Cards	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP FireWire/IEEE 1394a PCI Card	Υ	Υ	PA997A	
HP IEEE 1394b FireWire PCle Card	Υ	Υ	NK653AA	



Supported Components

Monitors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP LP3065 30-inch Widescreen LCD Monitor	Υ	Υ	EZ320A	
	HP DreamColor LP2480zx Professional Display	Υ	Υ	GV546A	
	HP LP2475w 24-inch Widescreen LCD Monitor	Υ	Υ	KD911A	
	HP LP2275w 22-inch Widescreen LCD Monitor	Υ	Υ	KE289A	
	HP LP1965 19-inch LCD Monitor	Υ	Υ	RA373A	
	NOTE C	LID /	1.		IV.

NOTE: Supported by all Operating Systems available from HP (screen size diagonally measured)

Networking and Communications		Factory Configured	Option Kit	Option Kit Part Number Support Notes
	Integrated Broadcom 5764 PCle LOM Controller	Υ	Ν	
	Broadcom NetXtreme Gigabit Ethernet Plus NIC (PCIe)	Υ	Υ	FS215AA
	HP NC360T PCI Express Dual Port Gigabit NIC	Ν	Υ	KU004AA
	Intel Gigabit CT Desktop NIC	Ν	Υ	FH969AA
	The Broadcom NetXtreme Plus card may be used, aloredundancy, or additional network bandwidth.	ong with the int	tegrated 5	764 LOM, for teaming,

"Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Racking and Physical				Option Kit	
Security		Factory Configured	Option Kit	Part Number	Support Notes
	Security Cable with Kensington Lock	Ν	Υ	PC766A	
	HP Solenoid Hood Lock & Hood Sensor	Υ	Ν		
	HP (CMT) Solenoid Lock	Ν	Υ	DE618A	
	HP Z6/Z8 Adjustable Sliding Rail Rack Kit	Ν	Υ	NN124AA	

Supported Components

Input Devices		_	_	Option Kit	
		Factory Configured	Option Kit	•	port otes
	HP PS/2 Standard Keyboard	Υ	Υ	DT527A	
	HP USB Standard Keyboard	Υ	Υ	DT528A	
	HP PS/2 Optical Scroll Mouse	Υ	Υ	EY703AA	
	HP USB 2-Button Optical Scroll Mouse	Υ	Υ	DC172B	
	HP USB Laser Mouse	Υ	Υ	GW405AA	
	HP USB Optical 3-Button Mouse	Υ	Υ	DY651A	
	HP USB Smart Card Keyboard	Ν	Υ	ED707AA	
	HP 2.4GHz Wireless Keyboard & Mouse	Ν	Υ	NB896AA	
	HP USB Optical 3-Button 2.9M OEM Mouse	Ν	Υ	ET424AA	
	HP SpaceExplorer 3D USB Controller	Ν	Υ	RY429AA	
	HP SpacePilot 3D USB Intelligent Controller	Ν	Υ	EF390AA	

Other Hardware		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Workstation Mouse Pad	Υ	Ν		Japan only.
	HP Power Cord Kit	Ν	Υ	DM293A	
	HP eSATA PCI Cable Kit	Ν	Υ	GM110AA	
	HP 2nd Serial Port Adapter	Ν	Y	PA716A	Provides 1st Serial Port for the Z600.
	HP Internal USB Port Kit	Ν	Υ	EM165AA	
	HP Workstation to LTO SAS Int. Cable	Ν	Υ	EH925A	
	HP Optical Bay HDD Mounting Bracket	Υ	Υ	NQ099AA	For 3.5" HDDs
	HP ENERGY STAR 5.0 Enabled Configuration	Υ	Ν		

Supported Components

Software		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Performance Tuning Framework	Υ	Ν		
	Roxio Easy Media Creator (CD or DVD burner)	Υ	Ν		
	Intervideo WinDVD with DVD player	Υ	Ν		
	HP Backup and Recovery	Υ	Ν		Supported on Windows XP ONLY
	PDF Complete	Υ	Ν		
	Microsoft Office 2007 Small Business Edition	Υ	Ν		
	Microsoft Office 2007 Trial Edition	Υ	Ν		
	HP Client Manager Software v6.2 (optional download)	Υ	Ν		
	HP ProtectTools Security	Y	N		Must select as a Configure to Order Option. Delivered as a "Drop in the Box" CD

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Ope	ratina	21	/stems

Support Notes

Genuine Windows Vista® Business 32-bit

Certain Windows Vista product features require advanced or additional hardware. See

www.microsoft.com/windowsvista/getready/hardwarereqs.mspx and www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit www.windowsvista.com/upgradeadvisor.

Genuine Windows Vista® Business 64-bit

Certain Windows Vista product features require advanced or additional hardware. See

www.microsoft.com/windowsvista/getready/hardwarereqs.mspx and www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit www.windowsvista.com/upgradeadvisor.

Genuine Windows Vista® Business 32-bit with downgrade to Windows® XP Professional 32-bit custom installed Windows Vista Business disk may also be included for future upgrade if desired. To qualify for this downgrade an end user must be a business (including governmental or educational institutions) and is expected to order at least 25 customer systems with the same custom image.

Genuine Windows Vista® Business 64-bit with downgrade to Windows® XP Professional x64 custom installed Windows Vista Business disk may also be included for future upgrade if desired. To qualify for this downgrade an end user must be a business (including governmental or educational institutions) and is expected to order at least 25 customer systems with the same custom image.

HP Linux Installer Kit see: http://www.hp.com/workstations/software/linux



0 0 :									
System Board									
System Board Form Factor	14.2 x 11 inches								
Processor Socket	Dual LGA 1366	al LGA 1366							
CPU Bus Speed	QPI: Up to 6.4GT/second, a	: Up to 6.4GT/second, depending on processor							
Chipset	Intel® 5520	I® 5520							
Super I/O Controller	SMSC SCH5327, Rev B	C SCH5327, Rev B							
Memory Expansion Slots	6 (3 per processor)								
Memory Type Supported	DDR3, UDIMM (Unbuffered)	, ECC	2						
Memory Modes	NUMA (Non-Uniform Memo	ory Ard	chitectur	e), Me	mory N	lode In	terleav	/e	
Memory Speed Supported	800, 1066, & 1333MHz								
Memory									
Maximum Memory	Supports up to 24GB								
			1		Dual P	'monano r			7
				CPUB			CPUI		
		Capacit 2GB	DIMMI 1GB	DIMM2	DDMD	1GB	DEMIM2	DEMENTS	-
		4GB	1CB	108		108	108		
		4GB 6GB	2 GB	108	108	2GB 1GB	1GB	1GB	
		8 CB	2 CB	2 CB	4.00	2CB	2GB		
		12GB 16GB	2GB 4GB	2GB 4GB	2GB	2GB 4GB	2GB 4GB	2GB	
		24GB	4CB	4CB	4CB	4CB	4CB	4CB	
		Г		Т	Single	Processor - Cl	700		
		Ė	Capacity	DOM		DDMM2	DIM	мз	
		H	1GB 2GB	10		108			
			3 CB	10		1CB	10	В	
		ŀ	4GB 6GB	2 G		2GB 2GB	2 G	В	
		F	8GB 12GB	4G		4GB	40		
		L	1200	40	9	400	40	ь	
Memory Configuration (Supported)	 Dual processor config supported. 	supp mod uratic	oorted. Jules into ons with	memo	ory slot ry mod	s if cor ules ins	respon stalled	ding p for or	processor is not installed. nly one processor is not 0 4GB DIMM. They are not
PCI Express Connectors (Gen2 Rev 0.7 connectors)	2 PCI Express x16 Gen2 gra 1 PCI Express Gen2 (x8 mec 1 PCI Express Gen1 (x8 mec	hanic	cally, x4						
PCI Connectors (5.0V)	2 full length 33 MHz 32-Bit								
Interfaces Supported	SATA			1, 5, 1		NCQ.			Gb/sec controller with RAID 0, egrated RAID is Microsoft
Serial Attached SCSI	Requires Optional PCle card	4							
Integrated RAID	Integrated SATA RAID								



system rechnical spe	ecincunons						
	 RAID 0, RAID 1*, RAID 5, RAID 10 Supports one RAID array with 2-4 drives RAID 0 configuration - striped array (supported and configure to order) RAID 1 configuration - mirrored array (supported and configure to order) RAID 5 parity striping (supported but not configure to order) RAID 10 striped and mirrored array (supported but not configure to order) 						
	NOTES: *HW RAID functionality not s Hat Operating system instead.	upported by Linux. Use SW RAID functionality provided in the Red					
Integrated Graphics	No						
Network Controller	Controller Broadcom 5764 PCI-E LAN Controller Memory Integrated 48KB receive buffer and 8KB transmit buffer Data rates supported 10/100/1000 Mbps Compliance IEEE 802.3, 802.3AB and 802.3u compliant, 802.3x flow control Bus architecture PCIe 1.0a Data path width X1 Data path speed 2.5Gbit per sec per direction transfer rate Data transfer mode Bus-master DMA Power requirement 1.0 watts @ +3.3V AUX supply Boot ROM support Yes Network transfer rate 10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-TX (full-duplex) 2000 Mbps Microsoft Windows Vista Business 32 and 64, Microsoft Windows XP Professional 32 and 64						
SATA Connectors	6 ports/connectors (Include 4 are eSA kit)	TA configurable with optional eSATA After-Market Option cable					
IEEE 1394a or 1394b	No integrated 1394a - optional PCI of No integrated 1394b - optional PCIe Cable from Front IO can be plugged Not supported in Linux	card required.					
IEEE 1394 Connector(s)	Front	1 IEEE 1394a (requires optional PCI card to function)					
	Rear	No					
	Internal	No					
USB Connector(s)	Front	3 on header for front					
	Rear	6					
	Internal	3					
Audio	High Definition Integrated Realtek ALC	C262 Audio with Line in, Line Out, Microphone, Headphone					
CD-ROM input/Audio	No						
AUX INPUT; Audio	Yes						
IEEE 1394 Connector(s)	Front	1 IEEE 1394a (requires optional PCI card to function)					
	Rear	No					
	Internal	No					
L	Internal	INO					



USB Connector(s)	Front	3 on header for front					
, ,	Rear	6					
	Internal	3					
HD Integrated Audio	High Definition Integrated Realtek ALC26 Line-in, Line-out, Mic-in x2, and Headpho	2 Audio with Line in, Line Out, Microphone, Headphone one jacks					
Flash ROM	Yes						
Clear Fan Header	No						
CPU Fan Header	One for each CPU socket						
Chasiss Fan Header	2 Rear System Chassis Fan Header 1 Optional Front Chassis Fan Header						
Front PCI Fan Header	Yes						
Front Control Panel/Speaker Header	Yes						
CMOS Battery Holder - Lithium	Yes						
Integrated Trusted Platform Module	TPM 1.2, Infineon						
Power Supply Headers	Yes						
Power Switch, Power LED & Hard Drive LED Header	Yes						
Clear Password Jumper	Yes						
Serial Port	Optional						
Parallel Port	No						
Keyboard/Mouse	PS/2						
Power Supply	650 watt 85% efficient custom power sup (Wide Ranging, Active PFC)	ply					
Operating Voltage Range	90-269 VAC						
Rated Voltage Range	100 - 240 VAC 118 VAC						
Rated Line Frequency	50/60Hz 400Hz						
Operating Line Frequency Range	47-66Hz 393-407 Hz						
Rated Input Current	10 A @ 100-127 VAC; 6 A @ 200-240 10 A @ 118 VAC	VAC					
Heat Dissipation	Typical = 434 btu/hr (109 kg-cal/hr) Maximum = 964 btu/hr (243 kg-cal/hr)						
Power Supply Fan	92x25 mm variable speed						
ENERGY STAR® qualified (Config Dependent)	Yes						
80 PLUS Compliant	Yes						



•	
FEMP Standby Power Compliant 115V (Wake- on LAN disabled) (<2W in S5 - Power Off)	Yes
Power consumption in sleep mode (as defined by ENERGY STAR) - Suspend to RAM (S3)	
Built-in Self Test (BIST) LED	Yes
Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V)	Withstands power surges up to 2000V
Hood Lock Header	Yes
Hood Sensor Header	Yes Integrated in Front Control Panel Cable
Multibay Header	No
Integrated Gigabit Ethernet	Integrated Broadcom 5764 Gigabit Ethernet LOM
Wake on LAN	Yes
ASF 1.0/2.0 (Alert Standard Format)	Yes
TPM	Integrated TPM 1.2; Infineon
Password Clear Header	Yes
CD-ROM ; analog audio cable	No
AUX ; analog audio in	No
Clear CMOS Button	Yes
Chassis Speaker Header	Yes (Integrated in Front Control Panel Cable)
ENERGY STAR® qualified (Config Dependent)	Yes



Z600 Required Power Supply Info					
Power Supply	650 watt custom power supply	- (Wide Ranging Active PFC)			
Operating Voltage Range	90 - 26	9 VAC			
Rated Voltage Range	100 - 240 VAC	118 VAC			
Rated Line Frequency	50-60 Hz	400 Hz			
Operating Line Frequency Range	47 - 66 Hz	393 - 407 Hz			
Rated Input Current	10 A @ 110-127 VAC 6 A @ 200-240 VAC	10 A @118 VAC			
Heat Dissipation (Configuration and software dependent)	Typical 1578 btu/hr (397.7 kg-cal/hr) Maximum 2705 btu/hr (681.8 kg-cal/hr)				
Power Supply Fan	2x60x25 mm variable speed (sleeve-bearing)fans				
Energy Star Compliant (config dependent)	YE	S			
80 PLUS® Compliant	Yes, B	ronze			
FEMP Standby Power Compliant@115V (Wake-on LAN disabled)(<2W in S5-Power Off)	YE	S			
EuP Compliant@230V (<1 W in \$5-Power Off)	YE	S			
Power Consumption in sleep mode (as defined by ENERGY STAR) - Suspend to RAM (S3) (Instantly Available PC) measured at 115V.	<9	W			
Built-in Selft Test LED	YE	S			
Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V	YE	S			



System Technical Specifications

System Configuration

Example
Configuration #1

Processor Info 1x Intel Xeon E5506

Memory Info 1x1 GB DDR3 1333 (UDIMM)

Graphics Info NVS290

Disks/Optical/Floppy 1x160GB SATA / 0 Optical / 0 Floppy

PSU 650W 80PLUS® BRONZE

Energy Consumption

	115 VAC		230	230 VAC		100 VAC		
Announce of the second	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
Windows Idle (S0)	62.2 W		61.8 W		63.1 W			
Windows Busy Typ(SO)	117,9 W		114.9 W		118.2 W			
Windows Busy Max (S0)	156	9 W	155	.1 W	157.5 W			
Sleep (S3)	3.71 W	3.47 W	4.05 W	3.84 W	3.69 W	3.44 W		
Off (S5)	1.14 W	1.32 W	1.45 W	1.32 W	1.12 W	0.99 W		
Zero Power Mode (EuP)	0.24	4 W	0.52 W		0.29W			

Heat Dissipation**

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows Idle (\$0)	212.4	btu/hr	210.8	btu/hr	215.2	btu/hr
Windows Busy Typ (SO)	402.3	btu/hr	392.0	btu/hr	403.4	btu/hr
Windows Busy Max (S0)	535.6	btu/hr	529.3	btu/hr	538.1	btu/hr
Sleep (S3)	12.7 btu/hr	11.8 btu/hr	13.8 btu/hr	13.1 btu/hr	12.6 btu/hr	11.7 btu/hr
Off (S5)	3.9 btu/hr	4.5 btu/hr	4.9 btu/hr	4.5 btu/hr	3.8 btu/hr	3.4 btu/hr
Zero Power Mode (EuP)	0.8 b	tu/hr	1.77	otu/hr	0.7 5	tu/hr

Example
Configuration #2

Processor Info 2 x Intel Xeon E5506

Memory Info 2x1GB DDR3 1333MHz (UDIMM)

Graphics Info 1xFX 580

Disks/Optical/Floppy 1x250GB SATA / 0 Optical / 0 Floppy

PSU 650W 80PLUS® BRONZE

Energy Consumption

	115 VAC		230 VAC		100 VAC		
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
Windows Idle (S0)	89.	89.2 W		87.8 W		90.0 W	
Windows Busy Typ(SO)	294.1 W		287.8 W		294.9 W		
Windows Busy Max (S0)	313	.5 W	307.3 W		317.0 W		
Sleep (\$3)	5.08 W	4.84 W	5.43W	5.25 W	5.05 W	4.82 W	
Off (S5)	1.14 W	1.01 W	1.45 W	1.32 W	1.12 W	0.99 W	
Zero Power Mode (EuP)	0.24 W		0.52 W		0.22 W		

Heat Dissipation**

	115 VAC		230 VAC		100 VAC	
	LAN	LAN	LAN	LAN	LAN	LAN
	Enabled	Disabled	Enabled	Disabled	Enabled	Disabled
: Windows Idle (SO)	304.5	btu/hr	299.5	btu/hr	307	otu/hr
Windows Busy Typ (SO)	1003.8	btu/hr	982.3	btu/hr	1006.5	btu/hr
Windows Busy Max (S0)	1070	btu/hr	1048.8	btu/hr	1081.9	btu/hr
Sleep (\$3)	17.3 btu/hr	16.5 btu/hr	18.5 btu/hr	17.9 btu/hr	17.2 btu/hr	16.5 btu/hr



System Technical Specifications

	Off (S5)	3.9 btu/hr 3.5 btu/hr	5.0 btu/hr 4.5 btu/hr	3.8 btu/hr 3.38 btu/hr
Ze	ro Power Mode (EuP)	0.8 btu/hr	1.8 btu/hr	0.8 btu/hr

Example
Configuration #3

Processor Info 2x Intel Xeon X5570
Memory Info 6x2GB DDR3 1333MHz (UDIMM)

Graphics Info 1 x FX4800

Disks/Optical/Floppy 2x1000GB SATA / 1 Optical / 1 Floppy PSU 1xBroadcom 5761 Gigabit PCIe NIC

650W 80PLUS® BRONZE

Energy Consumption

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows Idle (S0)	123	.3 W	119	.9 W	123	.6 W
Windows Busy Typ(S0)	455	.7 W	443	.0 W	462	.3 W
Windows Busy Max (S0)	564	.8 W	554.4 W		570.7 W	
Sleep (S3)	7.0 W	6.28 W	7.2 W	6.61 W	7.0 W	6.27 W
Off (S5)	1.6 W	0.90W	1.9 W	1.21W	1.6 W	0.88 W
Zero Power Mode (EuP)	0.24 W		0.51 W		0.22 W	

Heat Dissipation**

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows (dle (SO)	420.8	btu/hr	409.2	btu/hr	421.8	btu/hr
Windows Busy Typ (SO)	1555.3	btu/hr	1512.0	btu/hr	1577.8	btu/hr
Windows Busy Max (S0)	1927.7	btu/hr	1892.2	btu/hr	1947.8	btu/hr
Sleep (\$3)	23.9 btu/hr	21.4 btu/hr	24.6 btu/hr	22.6 btu/hr	23.9 btu/hr	21.4 btu/hr
Off (\$5)	5.5 btu/hr	3.1 btu/hr	6.5 btu/hr	4.1 btu/hr	5.5 btu/hr	3.0 btu/hr
Zero Power Mode (EuP)	0.8 b	tu/hr	1.7 b	tu/hr	0.8 b	tu/hr

System Technical Specifications

Example
Configuration #4
(ENERGY STAR
Qualified)

Processor Info 2x Intel Xeon X5570

Memory Info 6x2GB DDR3 1333MHz (UDIMM)

Graphics Info 1 x FX4800

Disks/Optical/Floppy 2x1000GB SATA / 1 Optical / 1 Floppy I/O 1xBroadcom 5761 Gigabit PCIe NIC

PSU 650W 80PLUS® BRONZE

Energy Consumption

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
On-Idle (ENERGY STAR® Idle (S0))	123.3 W		119.9 W		123.6 W	
ENERGY STAR® PMAX Windows running Linguisk and Viewpert	455.7 W		443.0 W		462.3 W	
ENERGY STAR® "Sleep" (S3)	7.0 W		7.2 W	<u>-</u> 4	7.0 W	1:4:
ENERGY STAR ^b "Standby" (Off) (S5)	1.6 W	· -	1.9 W	÷::	1.6 W	

Heat Dissipation**

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
On-Idle (ENERGY STAR [®] Idle (S0))	420.8 btu/hr		409,2 btu/hr		421.8 btu/hr	
ENERGY STAR® PMAX Windows running Linpack and Wemper	1555.3 <u>btu</u> /hr		1512.0 btu/hr		1577.8 btu/hr	
ENERGY STAR* "Sleep" (S3)	23.9 btu/hr	2 2	24.6 btu/hr	2:	23.9 btu/hr	1420
ENERGY STAR ⁵ "Standby" (Off) (S5)	5.5 btu/hr	· · · · · · · · · · · · · · · · · · ·	6.5 btu/hr	*:	5.5 btu/hr	

NOTES:

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.

Declared Noise Emissions (Entry-level and High-end configurations)					
System Configuration	Processor Info	Dual Intel Xeon X5570 2.93Ghz processors			
(Entry level)	Memory Info	4 x 1GB 1333Mhz			
	Graphics Info	nVidia Quadro NVS 295			
	Disks/Optical/Floppy	2x 250GB 7200 rpm SATA / 1 DVD-ROM/ 1 Floppy			

^{*} Energy Star low energy mode

^{**} Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions		Sound Power (LWAd, bels)	Deskside Sound Pressure
(in accordance with ISO	Idle	4.1	24
7779 and ISO 9296)	SATA Hard drive Operating (random reads)	4.2	26
	Floppy Drive Operating (continuous copy)	4.8	33
	DVD-ROM Operating (sequential reads)	5.1	36

-1 - 0	Processor Info	Dual Intel Xeon X5570 2.93GHz processors	
(High-end)	Memory Info	6 x 2GB 1333 Mhz	
	Graphics Info	nVidia FX4800	
	Disks/Optical/Floppy	2x300GB 15k SAS / 1 DVD-ROM/ 1 Floppy	

Declared Noise Emissions		Sound Power (LWAd, bels)	Deskside Sound Pressure
(in accordance with ISO	Idle	4.7	28
7779 and ISO 9296)	SATA Hard drive Operating (random reads)	4.9	31
	Floppy Drive Operating (continuous copy)	5.1	36
	DVD-ROM Operating (sequential reads)	5.3	30

Environmental Requirements	Temperature	Operating: 40° to 95° F (5° to 35° C) Non-operating: -40° to 140° F (-40° to 60° C)
	Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
	Maximum Altitude	Operating: 10,000 feet (3,000 m) Non-operating: 30,000 feet (9,100 m)
	Dynamic (new)	Shock Operating: ½-sine: 40g, 2-3ms Non-operating: ½-sine: 160 cm/s, 2-3ms (~100g) square: 422 cm/s, 20g NOTE: Values represent individual shock events and do not indicate repetitive shock events. Vibration Operating random: 0.5g (rms), 5-300 Hz Non-operating random: 2.0g (rms), 10-500 Hz NOTE: Values do not indicate continuous vibration.
	Cooling	Above 5000 ft (1524 m) altitude, maximum operating temperature is derated by 1.8° F (1° C) per 1000 ft (305 m) elevation increase



Physical Security an	nd Serviceability
Access Panel	Tool-less Includes system board and memory information
Optical Drive	Tool-less
Floppy Drive	Tool-less
Hard Drives	Tool-less
Expansion Cards	Tool-less
Processor Socket	Tool-less
Green User Touch Points	Yes, on tool-free internal chassis components
Color-coordinated Cables and Connectors	Yes
Memory	Tool-less
System Board	Tool-less
Dual Color Power and HD LED on Front of Computer	Yes
Configuration Record SW	Yes
Over-Temp Warning on Screen	Yes
Restore CD Set	Restores the computer to its original factory shipping image - Can be obtained via HP Support
Dual Function Front Power Switch	Yes, causes a fail-safe power off when held for 4 seconds
Padlock Support	Yes (optional): Locks side cover and secures chassis from theft 0.22-in diameter padlock loop at rear of system
Cable Lock Support	Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft 3 mm x 7 mm slot at rear of system
Universal Chassis Clamp Lock Support	Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows multiple units to be chained together when used with optional cable Threaded feature at rear of system
Solenoid Lock and Hood Sensor	Yes (optional) The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software and a password. You can also lock and unlock the chassis remotely over the network. The Sensor Kit detects when the access panel has been removed
Rear Port Control Cover	Yes, locks rear IO cables to prevent cable theft
Serial, Parallel, USB, Audio, Network, Enable/Disable Port Control	Yes, enables or disables serial, USB, audio, and network ports
Removable Media Write/Boot Control	Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media)
Power-On Password	Yes, prevents an unauthorized person from booting up the workstation
Setup Password	Yes, prevents an unauthorized person from changing the workstation configuration
3.3V Aux Power LED on System PCA	Yes



NIC LEDs (integrated) (Green & Amber)	Yes
CPUs and Heatsinks	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less
Power supply diagnostic LED	Yes
Power Button	Yes, ACPI multi-function
Power LED	Yes, blue (normal), red (fault)
Hard drive activity LED	Yes, green
Internal speaker	Yes
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS.
OS CD (Restore OS CD)	Restores computer to its original factory shipping Operating System - No recovery CDs will ship with Windows XP, Vista or Linux - an ISO image will be available on an HD partition.
ASF 2.0 support (Alert Standard Format)	Industry-standard specification for network alerting in operating system-absent environments
Cooling Solutions	Air cooled forced convection
Power Supply Fans	2x 60mm x 25mm
CPU Heatsink Fan(s)	80mm x 15mm
Chassis Fans	Rear: 2x 92mm x 25mm Front: 80mm x 25mm
Memory Fans	80mm x 25mm
Insight Diagnostics	HP Insight Diagnostics Offline Edition The diagnostics utility enables you to perform testing and to view critical computer hardware and software configuration information from various sources. This utility enables you to: • Run diagnostics • iew the hardware configuration of the system Key features and benefits HP Insight Diagnostics simplifies the process of effectively identifying, diagnosing, and isolating the hardware issues. In addition to robust management tools, service tools can be invaluable in quickly resolving system problems. To streamline the service process and resolve problems quickly, it is necessary to have the right information available at the time that a service call is placed. The primary information requirement, which is also the one that provides the greatest insight into potential system issues, is the configuration of the system. Insight Diagnostics helps provide higher system availability.
Access Panel Key Lock	 Typical uses of the Insight Diagnostics are: Testing and diagnosing apparent hardware failures Documenting system configurations for upgrade planning, standardization, inventory tracking, disaster recovery, and maintenance Sending configuration information to another location for more in-depth analysis Yes, prevents removal of the access panel and all internal components including optical and floppy



ACPI-Ready Hardware	 Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system
Trusted Platform Module Chip with optional ProtectTools Software	Yes, Infineon SLB9635TT1.2
Integrated Chassis Handles	Yes
Power Supply	Tool-less, direct-connect (blind-mate)
PCI Card Retention	Yes, rear (all), middle (full-height cards), front (full-length with extender cards)
Flash ROM	SPI ROM
Diagnostic Power Switch LED on board	Yes
Clear Password Jumper	Yes
Clear CMOS Button	Yes
CMOS Battery Holder for easy Replacement	Yes
DIMM Connectors for easy Upgrade	Yes
HP ProtectTools Security Manager	Yes - Not supported on Microsoft XP x64 or Linux

BIOS	
BIOS 32-bit Services	Standard BIOS 32-Bit Service Directory Proposal v0.4
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces
ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0
BBS	BIOS Boot Specification v1.01
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.
BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot.
BIOS Power On	Users can define a specific date and time for the system to power on
ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS
System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM
Replicated Setup	Saves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).
SMBIOS	System Management BIOS 2.5, previously known as DMI BIOS, for system management information
Boot Control	Disables the ability to boot from removable media on supported devices
Memory Change Alert	Alerts management console if memory is removed or changed



Thermal Alert	Monitors the temperature state within the chassis. Three modes:
	 NORMAL - normal temperature ranges ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer without warning before hardware component damage occurs
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console
ACPI (Advanced Configuration and Power Management Interface)	 Allows the system to enter and resume from low power modes (sleep states).] Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 2.0 for full compatibility with 64-bit operating systems.
Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen
Remote Wakeup/Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location
ASF 2.0 Compliant	Allows workstation status to be monitored on a remote console
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time
Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)	Allows a new or existing system to boot over the network and download software, including the operating system
ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.
System board revision level	 Allows management SW to read the revision level of the system board Revision level is digitally encoded into the HW and cannot be modified.
Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing
Auto Setup when new hardware installed	System automatically detects the addition of new hardware
Keyboard-less Operation	The system can be booted without a keyboard
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings
Asset Tag	Allows the user or MIS to set a unique tag string in non-volatile memory
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually
Adaptive Cooling	Fan control parameters are set according to detected hardware configuration for optimal acoustics
Pre-boot Diagnostics	Early (pre-video) critical errors are reported via beeps and blinks on the power LED
Industry Standard Specification Support	
Industry Standard	Revision Supported by the BIOS
ACPI	Advanced Configuration and Power Management Interface, Version 2.0
ASF	Alert Standard Format Specification, Version 2.0



ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b
CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0
EDD	 Enhanced Disk Drive Specification Version 1.1 BIOS Enhanced Disk Drive Specification Version 3.0
EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0
PCI	 PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft 0.7
PCI Express	PCI Express Base Specification, Revision 2.0
PMM	POST Memory Manager Specification, Version 1.01
SATA	 Serial ATA Specification, Revision 1.0a Serial ATA 3.0Gb/s: Extensions to Serial ATA 1.5Gb/s, Revision 1.0
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B
TPM	Trusted Computing Group TPM Specification Version 1.2
UHCI	Universal Host Controller Interface Design Guide, Revision 1.1
USB 1.1	Universal Serial Bus Revision 1.1 Specification
USB 2.0	Universal Serial Bus Revision 2.0 Specification
SMBIOS	System Management BIOS Reference Specification, Version 2.6

System Software Mo	anagement and Updating
HP Client Management	Visit: http://www.hp.com/go/easydeploy
Solutions	
Product Change	 Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile. PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition. Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.
Support Software CD & WWW	Yes
HP Client Manager	Visit: http://www.hp.com/go/easydeploy
System Software Manager (free)	Visit: http://www.hp.com/go/ssm
Social and Environmental Responsibility	
	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks: • ENERGY STAR (Configuration dependent, Microsoft Windows only) • US Federal Energy Management Program (FEMP) • China Energy Conservation Program • IT ECO declaration • Japan PC Green label* *This product conforms to the examination standards (2003 version) under JEITA's 'PC Green Label System.'



System Technical Specifications

Batteries

This product complies with ISO standards:

- EU Directive 91/157/EEC
- EU Directive 93/86/EEC
- EU Directive 98/101/EEC

Batteries used in the product do not contain:

- Mercury greater than 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 4000ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

Restricted Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Batteries Mercury
- Batteries Cadmium
- Batteries Lead (non-rechargeable)
- Batteries Non-rechargeable Alkaline and Carbon-Zinc Batteries
- Batteries Classification as "Not Restricted" for Transport
- Brominated Flame Retardants (PBBs, PBDEs, including DecaBDE)
- Brominated Flame Retardants (all BFRs in external case plastic parts)
- Cadmium and its compounds
- Certain Azo Colorants
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Formaldehyde emissions
- Hexavalent Chromium and its compounds in metallic applications
- Hexavalent Chromium and its compounds in non-metallic applications
- Lead and its compounds
- Lead in paint
- Lead in Polyvinyl Chloride (PVC) coating of external cables, wires and cords
- Mercury and its compounds
- Nickel on external surfaces
- Ozone Depleting Substances (ODS)
- Polycyclic Aromatic Hydrocarbons (PAH)
- Perfluorooctane sulfonates (PFOS) in parts
- Perfluorooctane sulfonates (PFOS) in preparations
- Polychlorinated Biphenyls (PCBs) and Polychlorinated Terphenyls (PCTs)
- Polychlorinated Naphthalenes
- Polyvinyl Chloride (PVC) in external case plastic parts
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging

HP Workstation product packaging meets the following (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html:



	 Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment (see link above). Does not contain ozone-depleting substances (ODS).
	 Design packaging materials for ease of disassembly. Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 ppm sum total for all heavy metals listed. Maximizes the use of post-consumer recycled content materials in packaging materials. All packaging material is recyclable. Reduces size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards. This product is designed to be upgraded, possibly extending its useful life by several years. Spare parts are available throughout the warranty period and for up to 5 years after the end of production. Upgradeability features contained in the product include: Intel LGA771 processor socket 8 USB ports (5 rear, 2 front, 1 internal) 2 PCI slots and 4 PCI Express slots 5/6 storage bays (2 - 3.5 inch OR 3 - 2.5" internal, 1 - 3.5 inch FDD, 2 - 5.25 inch removable)
	8 memory slots
Packaging Materials	0 11 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1
1	Cardboard carton and insert: 1.537 kg
	LDPE Foam: .740 kg
and Recycling	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.
Corporate Environmental Information	For more information about HP's commitment to the environment: [link to new HP white paper now in progress] Global Citizenship Report: http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications: http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html ISO 14001 certificates: http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html
Service, Support and Warranty	On-site Warranty and Service (Note 1): This three-year, limited warranty and service offering delivers three years of on-site, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) service for parts and labor and includes free telephone support (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering. NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country. NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries. HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack
i	Services Lookup Tool at http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at http://www.hp.com/hps/carepack. Service levels and response times for HP Care Packs may vary depending on your geographic location



- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive 2002/96/EC.
- Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 0% recycled materials (by weight)
- This product is >90% recycle-able when properly disposed of at end of life.



Technical Specifications - Processors

Processors

Intel Xeon E5504, 2.00GHz, 4MB cache, 800MHz Memory, 4.80 GT/s QPI, 80W Intel Xeon E5506, 2.13GHz, 4MB cache, 800MHz Memory, 4.80 GT/s QPI, 80W Intel Xeon E5520, 2.26GHz, 8MB cache, 1066MHz Memory, 5.86 GT/s QPI, 80W Intel Xeon E5530, 2.40GHz, 8MB cache, 1066MHz Memory, 5.86 GT/s QPI, 80W Intel Xeon E5540, 2.53GHz, 8MB cache, 1066MHz Memory, 5.86 GT/s QPI, 80W Intel Xeon X5550, 2.66GHz, 8MB cache, 1333MHz Memory, 6.40 GT/s QPI, 95W Intel Xeon X5560, 2.80GHz, 8MB cache, 1333MHz Memory, 6.40 GT/s QPI, 95W Intel Xeon X5570, 2.93GHz, 8MB cache, 1333MHz Memory, 6.40 GT/s QPI, 95W Intel Xeon X5570, 2.93GHz, 8MB cache, 1333MHz Memory, 6.40 GT/s QPI, 95W

Introduction

Intel's latest-generation microarchitecture represents the next step in unprecedented processor performance and dynamic scalability. Designed from the ground up to take advantage of hafnium-based Intel® 45nm hi-k metal gate silicon technology, Intel® Microarchitecture (Nehalem) unleashes parallel processing performance enabled by Intel® QuickPath technology providing an integrated memory controller and high-speed interconnect per independent processing core.

Performance and Features

Maximum multitasking performance Intel® Microarchitecture (Nehalem) offers the latest in processor innovation, including:

- Dynamic scalability, managed cores, threads, cache, interfaces, and power for energy-efficient performance on demand.
- Design and performance scalability for servers, workstations, notebooks and desktops with support for 2-8+ cores and up to 16+ threads with Intel® Hyper-Threading Technology (Intel® HT Technology), and scalable cache sizes, system interconnects, and integrated memory controllers.
- Intel® Turbo Boost Technology delivers additional performance automatically when needed by taking advantage of the processor's power and thermal headroom. This enables increased performance of both multi-threaded and single-threaded workloads.
- Intel Hyper-Threading Technology brings high-performance applications into mainstream computing with 1-16+ threads optimized for a new generation multi-core processor architecture.
- Scalable shared memory of Intel® QuickPath technology features memory distributed to each processor with integrated memory controllers and high-speed point-to-point interconnects to unleash the performance of future versions of nextgeneration Intel® multi-core processors.
- Multi-level shared cache improves performance and efficiency by reducing latency to frequently used data.

Turbo Boost Technology

This technology now built into Xeon 5500 processors will increase the speed of your processor on demand (from OS) if the CPU is operating below power / thermal specifications:

- Benefit of Turbo Boost (how much CPU speed up) depends on number of active cores
- Likelihood of Turbo Boost operation increases when less cores are active
- Likelihood of Turbo Boost operation increases when dynamic power mgt is enabled



Technical Specifications - Hard Drives

HP SAS (Serial Attached
SCSI) Hard Drives for HP
Workstations

300 GB (15K)

Capacity 300 GB
Height 1 in; 2.5 cm
Width Media Diam

Media Diameter3.5 in; 8.9 cmPhysical Size4 in; 10.2 cm

Interface SAS
Synchronous Transfer 3.0 Gb/s
Rate (Maximum)

Buffer 16 MB

Seek Time (typical reads, includes controller overhead, including settling)Single Track overhead, including full Stroke0.2 msAverage overhead, including settling)Full Stroke6.7 ms

Rotational Speed 15,000 rpm

Logical Blocks 585,937,500 - 512 byte blocks Operating Temperature 50° to 95° F (10° to 35° C)

146 GB (15K) Capacity 146 GB Height 1 in; 2.5 cm

 Width
 Media Diameter
 3.5 in; 8.9 cm

 Physical Size
 4 in; 10.2 cm

Interface SAS
Synchronous Transfer 3.0 Gb/s
Rate (Maximum)

Buffer 16 MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.2 msAverage
Full Stroke3.5 ms6.7 ms

Rotational Speed 15,000 rpm

Logical Blocks 86,749,488 - 512 byte blocks Operating Temperature 50° to 95° F (10° to 3°5 C)

 450 GB
 Capacity
 450 GB

 (15K)
 Height
 1 in; 2.5 cm

 Width
 Media Diameter
 3.5 in; 8.9 cm

 Physical Size
 4 in; 10.2 cm

Interface SAS
Synchronous Transfer 3.0 Gb/s
Rate (Maximum)

Buffer 16 MB

Technical Specifications - Hard Drives

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.2 msAverage
Full Stroke3.6 ms6.6 ms

Rotational Speed 15,000 rpm

Logical Blocks 879, 097, 968 - 512 byte blocks Operating Temperature 50° to 95° F (10° to 35° C)

SATA (Serial ATA) Hard 160,041,885,696

Drives for HP Workstations bytes (10K) **Capacity** 160,041,885,696 bytes

Height 1 in; 2.5 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.2 cm

Up to 150 MB/s

Interface Serial ATA (1.5 Gb/s), Native Command Queuing

enabled

Synchronous Transfer

Rate (Maximum)

Buffer 16 Mbytes

Seek Time (typical
reads, includes
controller overhead,
including settling)Single Track
Average0.3 msAverage
Full Stroke4.6 ms10.2 ms

Rotational Speed 10,000 rpm Logical Blocks 312,581,808

Operating Temperature 41 to 131 F (5 to 55 C)

1,000,204,886,016

bytes (7,200)

Capacity 1,000,204,886,016 bytes

Height 1 in; 2.5 cm

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4 in; 10.2 cm

Interface Serial ATA (3.0 Gb/s), Native Command Queuing

enabled

Synchronous Transfer

Rate (Maximum)

Up to 300 MB/s

Buffer 32 MB

Seek Time (typical
reads, includes
controller overhead,
including settling)Single Track
Average2 msAverage
Full Stroke11 ms21 ms

Rotational Speed 7,200 rpm Logical Blocks 1,953,525,168

Operating Temperature 41 to 131 F (5 to 55 C)

500,107,862,016 Capacity 500,107,862,016 bytes



Technical Specifications - Hard Drives

bytes Height 1 in; 2.5 cm (7,200)

Width Media Diameter 3.5 in; 8.9 cm

> Physical Size 4 in; 10.2 cm

Interface Serial ATA (3.0 Gb/s), Native Command Queuing

enabled

Synchronous Transfer

300 MB/s

Rate (Maximum)

Buffer 16 MB

Seek Time (typical Single Track 2 ms reads, includes Average 11 ms controller overhead, Full Stroke 21 ms including settling)

Rotational Speed 7,200 rpm 976,773,168 Logical Blocks

Operating Temperature 41 to 131 F (5 to 55 C)

250,059,350,016

bytes (7,200)

250,059,350,016 bytes Capacity

Height 1 in; 2.5 cm

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4 in; 10.2 cm

Serial ATA (3.0 Gb/s), Native Command Queuing Interface

enabled

Synchronous Transfer 300 MB/s

Rate (Maximum)

Buffer 16 MB

2 ms Seek Time (typical Single Track reads, includes 11 ms Average controller overhead, Full Stroke 21 ms including settling)

Rotational Speed 7,200 rpm 488,397,168 Logical Blocks

Operating Temperature 41 to 131 F (5 to 55 C)

160,041,885,696

bytes (7,200) Capacity 160,041,885,696 bytes

1 in; 2.5 cm Height

Width Media Diameter 3.5 in; 8.9 cm

> Physical Size 4 in; 10.2 cm

Interface Serial ATA (3.0 Gb/s), Native Command Queuing

enabled

Synchronous Transfer 300 MB/s

Rate (Maximum)

Buffer 8 MB



Technical Specifications - Hard Drives

Seek Time (typical Single Track 2 ms reads, includes Average 11 ms controller overhead, Full Stroke 21 ms including settling)

Rotational Speed 7,200 rpm 312,581,808 Logical Blocks

Operating Temperature 41 to 131 F (5 to 55 C)

300,069,052,416

bytes (10K) Capacity 300,069,052,416 bytes

Height 0.6 in; 1.53 cm

Width Media Diameter 2.5 in; 6.36 cm

> Physical Size 4 in; 10.17 cm

Interface Serial ATA (3.0Gb/s), Native Command Queuing

enabled

Synchronous Transfer Up to 300 MB/s

Rate (Maximum)

16 MB

Buffer

Seek Time (typical Single Track 0.7 ms (maximum)

reads, includes Average 4.4 ms controller overhead, Full Stroke 9.5 ms including settling)

10,000 rpm Rotational Speed 586,072,368 Logical Blocks

Operating Temperature 41° to 131° F (5° to 55° C)

320,072,933,376

bytes (7,200) Capacity 320,072,933,376 bytes

0.98 in; 2.5 cm Height

Width Media Diameter 3.5 in; 8.9 cm

> Physical Size 4.0 in; 10.17 cm

Serial ATA (3.0 Gb/s), Native Command Queuing Interface

enabled

300 MB/s Synchronous Transfer

Rate (Maximum)

Buffer 8 MB

2 Seek Time (typical Single Track reads, includes 12 Average controller overhead, Full Stroke 21 including settling)

Rotational Speed 7,200 rpm 625,142,448 Logical Blocks

Operating Temperature 41° to 131° F (5° to 55° C)

Technical Specifications - Hard Drive Controllers

LSI 3041E 4-Port SAS 3.0 PCI Bus PCI-Express x4 lanes Gb/s RAID Card PCI Modes Bus Master DMA

RAID Levels RAID 0, 1, 1E and 10E

PCI Data Burst Transfer

Rate

250 MB/s per lane half duplex 500 MB/s per lane full duplex 1,000 MB/s 4-lane half duplex

SAS Bandwidth Half Duplex Single lane – 300 MB/s

Wide Port (2 lanes) – 600 MB/s Wide Port (4 lanes) – 1200 MB/s

Full Duplex Single SAS Lane – 600 MB/s

Wide Port (2 lanes) –1200 MB/s Wide Port (4 lanes) – 2400 MB/s

PCI Card Type3.3 volt add-in cPCI Voltage $12 \text{ V} \pm 10\%$ PCI Power7.5 Watts

Bracket Full height and Low-profile

Certification Level PCI-Express 1.0a

IO Bus Four 3 Gb/s SAS/SATA ports

SAS Processor LSISAS1064E

Internal Connectors Four- SATA x1 connectors

External Connectors None
Maximum Number of 122

SCSI Devices

LED Indicators On-board activity and fault LEDs

Integrated Mirroring Integrated Mirroring option available

LSI MegaRAID® SAS 8888ELP Host Bus Adapter (HBA) PCI Bus PCI-Express x8 lanes
PCI Modes Bus Master DMA
RAID Levels RAID 0, 1, and 5
RAID spans 10 and 50

PCI Data Burst Transfer

Rate

Up to 3Gb/s per port

Full Duplex Up to 1.5 GB/s
PCI Voltage +3.3V Add-in Card

PCI Power 7.5 Watts

Certification Level PCI-Express 1.0a

IO Bus Eight 3Gb/s SAS/SATA ports

Internal Connectors Two SAS SFF8087 x4
External Connectors Two SAS SFF8088 x4

Maximum Number of

SCSI DeviceS

32



Technical Specifications - Hard Drive Controllers

LED Indicators

Connector LEDs indicate whether the internal or external connector is active for ports 0-3 and 4-7



Technical Specifications - Graphics

NVIDIA Quadro NVS 295 Form Factor

256MB Graphics Card

Graphics Controller

NVIDIA Quadro NVS 295 Graphics Board

Bus Type

PCI Express x16, Generation 2.0

Memory

256 MB GDDR3 SDRAM unified graphics memory

2.731 inches (H) \times 6.600 inches (L), Half-Height

Connectors 2 DisplayPort

Comes with 2 DisplayPort to DVI-D Adapters

('DisplayPort to VGA' and 'DisplayPort to DL DVI' adapters available as an

accessory)

Maximum Resolution

Display Output

Two DisplayPort outputs drive two digital displays up to 2560 x 1600

Drives DisplayPort enabled digital displays at resolutions up to 2560

imes 1600 at 60 Hz with reduced blanking

ullet Drives DVI enabled digital displays at resolutions up to 1920 imes 1200 at 60 Hz with reduced blanking (through DisplayPort to DVI-D (single

link) cable)

Supported Graphics APIs

OpenGL 3.0 DirectX 10.0

Available Graphics

Drivers

Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

Power consumption 22.69 Watts

NVIDIA Quadro NVS 450 Form Factor

512 MB PCle Graphics

Card

ATX Full Height, 1/2 length

Passive cooling

Bus Type PCI Express x16, Generation 2.0

Memory 512 MB GDDR3 (256MB per GPU)

Connectors Four DisplayPort;

Four DisplayPort to DVI-D adapters included.

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as

an accessory)

Maximum Resolution DisplayPort connectors support ultra-high-resolution panels (up to 2560 x

1600)

Supported Graphics APIs OpenGL 3.0

Direct X 10.0

Available Graphics

Drivers

Genuine Microsoft Windows Vista(64-bit and 32-bit), Microsoft Windows XP

Professional(64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation

HP qualified drivers may be preloaded or available from the HP support web

site: http://welcome.hp.com/country/us/eng/software drivers.html.

Novell SUSE Linux Enterprise drivers may be obtained from:



Technical Specifications - Graphics

ftp://download.nvidia.com/novell or http://www.nvidia.com

35 Watts Power consumption

NVIDIA Quadro NVS 290 Form Factor 256 MB PCle Graphics Card

Bus Type

Low Profile PCle x16

Memory 256 MB 400MHz DDR2 SDRAM unified frame buffer, Z-buffer and Texture

storage

Connectors DMS-59, includes DMS-59 to Dual DVI-I cable. DMS-59 to Dual VGA cable

available as an option.

Maximum Resolution Dual integrated analog display controllers supporting up to two analog

displays at 2048x1536 @ 85Hz on both displays or dual digital displays at

1920x1200 (single-link).

NVIEW advanced multi-display desktop and application management

seamlessly integrated into Microsoft® Windows®

RAMDAC Integrated dual 400MHz

Image Quality Features Full-screen, full-frame video playback of HDTV and DVD content

DVD-ready motion compensation for MPEG-2

Independent hardware color controls for video overlay Hardware color-space conversion (YUV 4:2:2 and 4:2:0)

IDCT motion compensation

5-tap horizontal by 3-tap vertical filtering

8:1 up/down scaling

Programmable Video

Processor

Full-screen, full-frame video playback of HDTV and DVD content

DVD-ready motion compensation for MPEG-2

Independent hardware color controls for video overlay Hardware color-space conversion (YUV 4:2:2 and 4:2:0)

IDCT motion compensation

5-tap horizontal by 3-tap vertical filtering

8:1 up/down scaling

Display Output Dual integrated analog display controllers supporting up to two analog

displays at 2048x1536 @ 85Hz on both displays or dual digital displays at

1920x1200 (single-link).

NVIEW advanced multi-display desktop and application management

seamlessly integrated into Microsoft® Windows®

Supported Graphics APIs

OGL 2.1 & DX10 Support; Shader Model 4.0

Available Graphics Drivers

Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP Professional(64-bit and 32-bit)(Provides full native Dual View mode, Span or

Big Desktop mode, and Clone mode)

Red Hat Enterprise Linux(RHEL) WS3, WS4 & 5 Desktop/Workstation

HP qualified drivers may be preloaded or available from the HP support web

site: http://welcome.hp.com/country/us/eng/software drivers.html. Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

High-Resolution AntiAliasing

Color planes: 32-bit color buffer Overlay planes: Hardware supported



Technical Specifications - Graphics

CUDA™ Parallel Processor Cores NVIDIA Quadro NVS 290 (256 MB DH) PCIe Graphics Card with full height bracket attached, DMS-59 to Dual DVI cable, Workstation Software Driver

CD, documentation.

NVIDIA Quadro FX 380 256MB Graphics Card Form Factor 4.376 inches (H) \times 6.60 inches (L)

Graphics Controller NVIDIA Quadro FX 380 Graphics Board

Bus Type PCI Express x16, Generation 2.0

Memory 256 MB GDDR3 SDRAM unified graphics memory

Connectors 2 Dual Link DVI-I

Two DVI-I to VGA adapters included

Maximum Resolution Two dual-link DVI-I outputs drive two digital displays at resolutions up to

 $2560 \ x \ 1600 \ @ \ 60 Hz$ or two analog displays at resolutions up to $2048 \ x$

1536 @ 85Hz

RAMDAC Dual Internal 400 MHz DAC

Shading architecture Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class)

Long fragment programs (unlimited instructions)

Long vertex programs (unlimited instructions)

Looping and subroutines (up to 256 loops per vertex program)

Dynamic flow control

Conditional execution

Supported graphics APIs OpenGL 3.0

Direct X 10.0

Available graphics drivers Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP

Professional(64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

High-level Shader Languages Optimized compiler for Cg and Microsoft HLSL

OpenGL 2.1 and DirectX 10 support

Open source compiler

CUDA™ Parallel Processor Cores

16

Power consumption 33.91 Watts

Technical Specifications - Graphics

ATI FirePro V3700 256MB Graphics Card Form Factor 4.40 inches (H) \times 6.70 inches (L) (11.18 cm (H) \times 17.02 cm (L))

Graphics Controller ATI FirePro V3700 Graphics Board Bus Type PCI Express x16, Generation 2.0

Memory 256 MB GDDR3 SDRAM unified graphics memory

Connectors 2 Dual Link DVI-I

Two DVI-I to VGA adapters included

Maximum Resolution Two dual-link DVI-I outputs drive two digital displays at resolutions up to

2560 x 1600 @ 60Hz or two analog displays at resolutions up to 2048 x

1536 @ 85Hz

Shading architecture Full Shader Model 4.0

• 40 Stream Processing Units

 Dynamic load balancing and resource allocation for vertex, geometry, and pixel shaders

and pixel shaders

Common instruction set and texture unit access supported for all types

of shadersDedicated branch execution units and texture address processors

HP qualified drivers may be preloaded or available from the HP support

Supported graphics APIs

OpenGL 2.1

DirectX 10.1 **Available graphics drivers** Genuine Windows Vista Business (64-bit and 32-bit)

Microsoft Windows XP Professional (64-bit and 32-bit)

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Web site:

http://welcome.hp.com/country/us/en/support.html

Linux drivers may be obtained from: http://ati.amd.com/support/driver.html

Power consumption 32 Watts

NVIDIA Quadro FX 580 512MB Graphics Card

Form Factor 4.376 inches (H) \times 6.60 inches (L)

Graphics Controller NVIDIA Quadro FX 580 Graphics Board

Bus Type PCI Express x16, Generation 2.0

Memory 512MB GDDR3 SDRAM unified graphics memory

Connectors 2 DisplayPort, 1 Dual-Link DVI-I.

One DisplayPort to DVI and one DVI to VGA adapter included

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as an accessory)

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Maximum Resolution

• Two DisplayPort outputs drive two digital displays up to 2560 x 1600

 One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up to

2048 x 1536 @ 85Hz

RAMDAC Single Internal 400 MHz DAC

Shading architecture Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class)

Long fragment programs (unlimited instructions)



Technical Specifications - Graphics

Long vertex programs (unlimited instructions)

Looping and subroutines (up to 256 loops per vertex program)

Dynamic flow control

Conditional execution

Supported graphics APIs

OpenGL 3.0

Direct X 10.0

Available graphics drivers Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP

Professional(64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

High-level Shader Languages

Optimized compiler for Cg and Microsoft HLSL

OpenGL 2.1 and DirectX 10 support

Open source compiler

CUDA™ Parallel **Processor Cores**

32

Power consumption

40 Watts

NVIDIA Quadro FX 1800 Form Factor 768MB Graphics Card

4.376 inches (H) x 7.8 inches (L)

Graphics Controller

NVIDIA Quadro FX 1800 Graphics Board

Bus Type

PCI Express x16, Generation 2.0

Memory

768MB GDDR3 SDRAM unified graphics memory

Connectors

2 DisplayPort, 1 Dual-Link DVI-I.

One DisplayPort to DVI-D and one DVI to VGA adapter included

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as

an accessory)

Maximum Resolution

• Two DisplayPort outputs drive two digital displays up to 2560 x 1600

• One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up to

2048 x 1536 @ 85Hz

RAMDAC

Single Internal 400 MHz DAC

Shading Architecture

Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class)

- Long fragment programs (unlimited instructions)
- Long vertex programs (unlimited instructions)
- Looping and subroutines (up to 256 loops per vertex program)
- Dynamic flow control
- Conditional execution

Supported Graphics APIs

OpenGL 3.0 Direct X 10.0

Available Graphics

Drivers

Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP Professional(64-bit and 32-bit)



Technical Specifications - Graphics

Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

High-level Shader Languages

Optimized compiler for Cg and Microsoft HLSL

OpenGL 2.1 and DirectX 10 support

Open source compiler

CUDA™ Parallel **Processor Cores**

64.

Power consumption

59 Watts

ATI FirePro V5700 512MB Graphics Card Form Factor

4.40 inches (H) \times 6.70 inches (L) (11.18 cm (H) \times 17.02 cm (L))

Graphics Controller

ATI FirePro V5700 Graphics Board PCI Express x16, Generation 2.0

Bus Type Memory

512 MB GDDR3 SDRAM unified graphics memory

Connectors

2 DisplayPort, 1 Dual-Link DVI-I.

One DisplayPort to DVI and one DVI to VGA adapter included

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as

an accessory)

Maximum Resolution

• Two DisplayPort outputs drive two digital displays up to 2560 x 1600

One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up to

2048 x 1536 @ 85Hz

Shading architecture

Full Shader Model 4.0

320 Stream Processing Units

 Dynamic load balancing and resource allocation for vertex, geometry, and pixel shaders

Common instruction set and texture unit access supported for all types of shaders

Dedicated branch execution units and texture address processors

Supported graphics APIs

OpenGL 2.1 DirectX 10.1

Available graphics drivers Genuine Windows Vista Business (64-bit and 32-bit)

Microsoft Windows XP Professional (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

Linux drivers may be obtained from: http://ati.amd.com/support/driver.html

Power consumption

56 Watts



Technical Specifications - Graphics

NVIDIA Quadro FX 3800 Form Factor 1.0GB Graphics Card (NOT AVAILABLE UNTIL Graphics Co.

JUNE 2009)

Form Factor 4.376 inches (H) x 9.0 inches (L)

Single slot card

Graphics Controller NVIDIA Quadro FX 3800 Graphics Board

Bus Type PCI Express x16, Generation 2.0

Memory 1GB GDDR3 SDRAM unified graphics memory

Connectors 2 DisplayPort, 1 Dual-Link DVI-I.

One DisplayPort to DVI-D and one DVI to VGA adapter included

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as

an accessory)

Maximum Resolution ■ Two DisplayPort outputs drive two digital displays up to 2560 x 1600

 One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up to

2048 x 1536 @ 85Hz

RAMDAC Single Internal 400 MHz DAC

Shading architecture Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class)

• Long fragment programs (unlimited instructions)

• Long vertex programs (unlimited instructions)

Looping and subroutines (up to 256 loops per vertex program)

Dynamic flow control

Conditional execution

Supported graphics APIs OpenGL 3.0

Direct X 10.0

Available graphics drivers Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP

Professional(64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

High-level Shader

Languages

Optimized compiler for Cg and Microsoft HLSL

OpenGL 2.1 and DirectX 10 support

Open source compiler

CUDA™ Parallel

Processor Cores

Power consumption

ssor Cores

107.9 Watts

192



Technical Specifications - Graphics

ATI FirePro V7750 1.0GB Form Factor

Graphics Card

Graphics Controller

ATI FirePro V7750 Graphics Board

Bus Type PCI Express x16, Generation 2.0

Memory 1024 MB GDDR3 SDRAM unified graphics memory

Connectors 2 DisplayPort, 1 Dual-Link DVI-I.

One DisplayPort to DVI and one DVI to VGA adapter included

4.40 inches (H) \times 13.0 inches (L) (11.18 cm (H) \times 33.02 cm (L))

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as

an accessory)

Maximum Resolution

• Two DisplayPort outputs drive two digital displays up to 2560 x 1600

One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up to

2048 x 1536 @ 85Hz

Shading architecture

Full Shader Model 4.0

• 320 Stream Processing Units

Dynamic load balancing and resource allocation for vertex, geometry, and pixel shaders

Common instruction set and texture unit access supported for all types of shaders

Dedicated branch execution units and texture address processors

Supported graphics APIs

OpenGL 2.1

DirectX 10.1

Available graphics drivers Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Linux drivers may be obtained from: http://ati.amd.com/support/driver.html

Power consumption 76 Watts



Technical Specifications - Graphics

NVIDIA Quadro FX 4800 Form Factor

1.5GB PCle Graphics Card

Graphics Controller

Bus Type

Memory Connectors PCI Express x16, Generation 2.0

4.36" (H) x 10.5" (L)

Dual slot card

1.5 GB GDDR3 SDRAM unified graphics memory

2 DisplayPort, 1 Dual-Link DVI-I, 1 3-pin Mini DIN stereo output, Two

DisplayPort to DVI-D adapters included

NVIDIA Quadro FX 4800 graphics board

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as

an accessory)

Maximum Resolution

• 2 DisplayPort connectors support ultra-high-resolution panels (up to 2560 x 1600)

Dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz

Internal 400 MHz DACs-One analog display up to 2048 x 1536 @

85Hz

Shading Architecture

Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class)

Long fragment programs (unlimited instructions) Long vertex programs (unlimited instructions)

Looping and subroutines (up to 256 loops per vertex program)

Dynamic flow control

Conditional execution

Supported Graphics APIs

OpenGL 3.0

Direct X 10.0

Available Graphics

Drivers

Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation

HP qualified drivers may be preloaded or available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

High-Resolution **AntiAliasing**

Rotated Grid Full-Scene Antialiasing (RG FSAA)

32xFSAA dramatically reduces visual aliasing artifacts or "jaggies" at resolution up to 1920 x 1200

64x FSAA SLI Mode

High-level Shader Languages

Optimized compiler for Cg and Microsoft HLSL

OpenGL 2.1 and DirectX 10 support

Open source compiler

CUDA™ Parallel **Processor Cores**

192

Power consumption

146 Watts



Technical Specifications - Graphics

NVIDIA	\ Quac	Iro CX

Form Factor 4.36" (H) x 10.5" (L)

Dual slot card

Graphics Controller

NVIDIA Quadro CX 1.5GB Graphics Card

Bus Type

PCI Express x16, Generation 2.0

Memory

1.5 GB GDDR3 SDRAM unified graphics memory

Connectors 2 DisplayPort, 1 Dual-Link DVI-I, 1 3-pin Mini DIN stereo output.

Two DisplayPort to DVI-D adapters included

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as

an accessory)

Maximum Resolution

 2 DisplayPort connectors support ultra-high-resolution panels (up to 2560 x 1600)

 Dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz

 Internal 400 MHz DACs-One analog display up to 2048 x 1536 @ 85Hz

RAMDAC

400MHz

Shading Architecture

• Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class)

• Long fragment programs (unlimited instructions)

Long vertex programs (unlimited instructions)

Looping and subroutines (up to 256 loops per vertex program)

Dynamic flow control

Conditional execution

Supported Graphics APIs

OpenGL 3.0

Direct X 10.0

Available Graphics

Drivers

Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

High-Resolution AntiAliasing Rotated Grid Full-Scene Antialiasing (RG FSAA)

 32xFSAA dramatically reduces visual aliasing artifacts or "jaggies" at resolution up to 1920 x 1200

• 64x FSAA SLI Mode

High-level Shader Languages Optimized compiler for Cg and Microsoft HLSL

OpenGL 2.1 and DirectX 10 support

Open source compiler

CUDA™ Parallel Processor Cores 192

Power consumption

146 Watts



Technical Specifications - Multimedia and Audio Devices

Integrated Intel/Realtek HD ALC262 Audio

Integrated Type

High Definition Codec Yes FM Synthesis Support Yes **OPL3 FM Synthesis** Yes

Support

Sound Blaster Yes

Compatibility

Meets Premium Yes performance for Windows Logo Program 3.0

Audio Jacks Front panel microphone in and headphone out - fixed usage.

Rear panel line in and line out jacks - jacks are retaskable

One Line-In* (12-K ohm Input Impedance)*

NOTE: External Speakers need to be powered externally.

Sampling 3 stereo ADCs support 16/20-bit PCM format with 44.1K/48K/96kHz

sample rate

2 stereo DAC supports 16/20/24-bit PCM format with

44.1K/48K/96K/192kHz sample rate

Wavetable Syntheses

(software)

Yes – GM and FM Midi Support, Direct Music and Down Loadable Soundset

(4 Meg DLS Level 1 and 2 Support)

3D Positional Sound No Digital Audio Yes **Analog Audio** Yes **DVD** Audio Yes

Number of Channels on

Line-Out

Stereo (Left & Right channels)

Internal Audio Speaker

Power Rating

1.5 W

Internal Speaker

Hardware Equalizer for

Internal Speaker

External Speaker Jack

Yes

Yes

No

(Line-Out)

Technical Specifications - Multimedia and Audio Devices

SoundBlaster (Creative Labs) X-Fi Titanium PCle Audio Card

24-bit Analog-to-Digital conversion of analog

96kHz sample rate

inputs

24-bit Digital-to-Analog

conversion of digital

96kHz to analog 7:1 speaker output

sources

24-bit Digital-to-Analog

8, 11.025, 16, 22.05, 24, 32, 44.1, 48 and 96kHz

conversion of stereo digital sources

16-bit to 24-bit recording 16-bit/44.1kHz, 16-bit/48kHz, 24-bit/44.1kHz, 24-bit/48kHz and 24-

sampling rates

bit/96kHz with direct monitoring

Enhanced SoundFont

Up to 24-bit resolution

support

Signal-to-Noise Ratio

109dB

(2okHz Low-pass filter, A-

Weighted)

Total Harmonic Distortion .004%

+ Noise at 1kHz (20kHz

Low-pass filter)

Frequency Response (-

10Hz to 46kHz

3dB, 24-bit/96kHz input)

Frequency Response (-10Hz to 46kHz

3dB, 24-bit/192kHz input)

Speaker and Headphone Stereo to 7.1 (Line Out via three 3.5mm mini jacks)

connections

Flexijack Line In/ Microphone In/Optical Out via shared 3.5mm mini jack

Front Panel Header Intel HD Audio Compatible (2x5 pin) Operating System Microsoft Windows Vista Business 64

> Microsoft Windows Vista Business 32 Microsoft® Windows® XP Professional SP2 Microsoft Windows XP Professional x64 Edition

512MB Minimum System System RAM

Requirements Windows Vista 32-bit and 64-bit version or Operating System

Windows XP 32-bit or 64-bit version

Technical Specifications - Optical and Removable Storage

NOTE 1: Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

HP DVD-ROM Drive	Description	5.25-inch, half-height, tray-load
------------------	-------------	-----------------------------------

Mounting Orientation Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)

Disc Capacity DVD-ROM Single layer: Up to 4.7 GB Double layer: Up to

8.5 GB

Access Times DVD-ROM Single Layer < 140 ms (typical)

CD-ROM Mode 1 < 125 ms (typical)

Full Stroke DVD < 250 ms (seek)

Full Stroke CD < 210 ms (seek)

Power SATA DC power receptacle

DC Power Requirements 5 VDC \pm 5%-100 mV ripple p-p

 $12 \text{ VDC} \pm 5\%$ -200 mV ripple p-p

DC Current 5 VDC - <1000 mA typical, < 1600 mA

maximum

12 VDC - < 600 mA typical, < 1400 mA

maximum

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions noncondensing) Relative Humidity 10% to 90% Maximum Wet Bulb 86° F (30° C)

Temperature

Operating Systems

Supported

Windows Vista Business 64* Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or

Windows XP Home 32*.

Red Hat Enterprise Linux(RHEL) WS3, WS4, 5

Desktop/Workstation Novell SLES 9 & SLE 10

No driver is required for this device. Native support is provided by the operating system.

* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine

which features of Windows Vista will run on your

computer. To download the tool, visit: http://www.windowsvista.com/

upgradeadvisor. For Windows Vista system

requirements, visit:

http://www.windowsvista.com/

systemrequirements.



Technical Specifications - Optical and Removable Storage

HP DVD+/-RW Drive	Description	5.25-inch, half-height, tray-load
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Mounting Orientation Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)

Disc Formats DVD-RAM

DVD+RDVD+RWDVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

> Full Stroke DVD < 250 ms (seek) Full Stroke CD < 210 ms (seek)

Maximum Data Transfer

Rates

CD ROM Read CD-ROM, CD-R Up to 40X

CD-RW Up to 32X

DVD ROM Read DVD-RAM Up to 12X

> DVD+RWUp to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 16X DVD-ROM DL Up to 8X DVD+RUp to 16X DVD-R Up to 16X

Power Source SATA DC power receptacle

> DC Power Requirements $5 \text{ VDC} \pm 5\%\text{-}100 \text{ mV ripple p-p}$

 $12 \text{ VDC} \pm 5\%$ -200 mV ripple p-p

DC Current 5 VDC -1000 mA typical, 1600 mA maximum 12 VDC -600 mA typical, 1400 mA maximum

Operating Environmental Temperature

(all conditions noncondensing)

41° to 122° F (5° to 50° C)

Relative Humidity 10% to 90% Maximum Wet Bulb 86° F (30° C)

Temperature

Operating Systems

Supported

Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*,

Windows 2000, Windows XP Professional or

Windows XP Home 32*.

Red Hat Enterprise Linux(RHEL) WS3, WS4, 5

Desktop/Workstation Novell SLES 9 & SLE 10

No driver is required for this device. Native



Technical Specifications - Optical and Removable Storage

support is provided by the operating system.

* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. For Windows Vista system requirements, visit:

http://www.windowsvista.com/

systemrequirements.

* LightScribe functionality is not natively supported by Linux distributions. Customers may download LightScribe Linux drivers from:

http://www.lightscribe.com/ downloadSection/linux/index.aspx

Kit Contents

HP SATA SuperMulti LightScribe DVD Writer drive, LightScribe software, Roxio Easy Media Creator software, Intervideo WinDVD Software, installation

guide, and DVD+R media.

HP Slot Load DVD+/-RW Description

Drive

Slim-Line, Slot-load

Mounting Orientation Either horizontal or vertical

SATA Interface Type

Dimensions (WxHxD) 5 x .5 x 5 in (12.7 x 1.2 x 12.9 cm) 0

DVD-RAM DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R Disc Formats

CD-RW

DVD-ROM **Disc Capacity** 5/9/10/18 G DVD-Single / Dual (PTP, OTP)

(Read Only)

4.7G DVD±R/RW (Read & Write) DVD±R Dual (Read & Write)

80mm DVD

DVD-RAM (Read & Write)

CD-ROM 650 MB CD-ROM (Read Only)

80mm CD

800/700/650/ CD-Recordable (Read & Write) 700/650MB CD-Rewritable (Read & Write) 700/650MB High Speed CD-Rewritable (Read &

Write)

700/650MB Ultra & Ultra + Speed CD-

Rewritable (Read & Write)

Full Stroke DVD < 270 ms (seek) Full Stroke CD < 250 ms (seek)

Maximum Data Transfer

Rates

CD ROM Read **DVD ROM Read**

CD-ROM, CD-R and CD-RW Up to 24X DVD-RAM Up to 5X DVD Single layer Up to 8X

DVD Dual Layer up to 6X



Technical Specifications - Optical and Removable Storage

	Operating Environmental (all conditions non- condensing)	Source DC Power Requirements DC Current Temperature Relative Humidity Operating Systems Supported	5 VDC 40 mA typical, 800 mA maximum 41° to 122° F (5° to 50° C) 10% to 90% Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 3 Windows XP Professional or Windows XP Ho 32*.	
	Vit Contants	Red Hat Enterprise Linux(RHEL) WS3, WS4, 5 Desktop/Workstation Novell SLES 9 & SLE 10 No driver is required for this device. Native support is provided by the operating system.		
		Kit Contents	Factory integrated only. Not available as a kit.	

HP Blu-Ray	√ Writer
------------	----------

Description	5.25-inch, half-height, tray-load	
Mounting Orientation	Either horizontal or vertical	

SATA

Interface Type

Dimensions (WxHxD)

Disc Formats

5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)

BD-ROM BD-R BD-RE DVD-RAM DVD+RDVD+RWDVD+R DL DVD-R DL DVD-R DVD-RW CD-R

Disc Capacity

DVD-ROM 8.5 GB DL or 4.7 GB standard

50 GB DL or 25 GB standard Blu-ray

Full Stroke DVD < 250 ms (seek) Full Stroke CD < 210 ms (seek)

Blu-ray Blu-ray

Startup Time (Time to drive ready from tray

loading)

CD-RW

BD-ROM (SL/DL) 25\$ / 28\$ BD-R (SL/DL) 25\$ / 28\$ BD-RE (SL/DL) 25\$ / 28\$ DVD-ROM (SL/DL) 185 / 185 25\$ / 25\$ DVD-R (SL/DL) DVD-RW **25S** DVD+R (SL/DL) 25S / 25S DVD+RW**25S**



Technical Specifications - Optical and Removable Storage

		DVD-RAM	45S
		CD-ROM	45S
Maximum Data Transfer	CD ROM Read	CD-ROM	Up to 40X
Rates		CD-R	Up to 40X
		CD-RW	Up to 40X
	DVD ROM Read	DVD-RAM	Up to 5X
		DVD+RW	Up to 10X
		DVD-RW	Up to 10X
		DVD+R DL	Up to 8X
		DVD-R DL	Up to 8X
		DVD-ROM	Up to 16X
		DVD-ROM DL	Up to 8X
		DVD+R	Up to 12X
		DVD-R	Up to 12X
	Blu-Ray	BD-ROM	Up to 6X
		BD-ROM DL	Up to 4.8X
		BD-R	Up to 6X
		BD-R DL	Up to 4.8X
		BD-R	Up to 6X
		BD-RE SL/DL	Up to 4.8X
Power	Source	SATA DC power receptor	acle
	DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 10%-100 mV ripple p-p	
	DC Current	5 VDC -900 mA typical, 1200 mA maximum 12 VDC -1000 mA typical, 1600 mA maximum	
Operating Environmental	Temperature	41° to 122° F (5° to 50° C)	
(all conditions non-	Relative Humidity	15% to 80%	
condensing)	Maximum Wet Bulb Temperature	86° F (30° C)	
	Operating Systems Supported	Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS3, WS4, 5 Desktop/Workstation Novell SLES 9 & SLE 10	
	Kit Contents	No driver is required for this device. Native support is provided by the operating system. HP Blue Laser RW Drive, LightScribe software, Roxio Easy Media Creator software, Intervideo WinDVD Software, installation guide.	



Technical Specifications - Optical and Removable Storage

Disclaimer

As Blu-Ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-Ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

HP 22-in-1 Media Card

Reader

Description

The Media Card Reader device uses the same physical form factor and mounting as a Floppy Disk Drive. The device connects to a 2x5 two-channel USB header on the motherboard of the system. There is no USB controller card provided. Please see the Disc Formats section below for a list of flash memory card formats that are supported.

Mounting Orientation

The Media Card Reader can be mounted in a dedicated Floppy Drive bay (if the chassis provides one) or in an appropriate Optical Bay adapter. It will operate in any orientation.

Interface Type

USB 2.0 (one channel dedicated to the separate USB port; one channel dedicated to the flash memory card slots)

Dimensions (WxHxD)

4.9 x 4.0 x 1.0 in (124.5 x 101.6 x 25.4 mm)

Disc Formats

xD-Picture Micro SD Micro SDHC

SD SDHC Mini SD Mini SDHC

MultiMediaCard (MMC)

Reduced Size MultiMediaCard (RS MMC)

MultiMedia Card 4.2 (MMC Plus, including MMC Plus HC)

Reduced Size MultiMedia Card 4.2 (MMC Mobile, including MMC Mobile

HC)

CompactFlash Card Type I CompactFlash Card Type II

MicroDrive Memory Stick (MS)

MagicGate Memory Stick (MG) MagicGate Memory Stick Duo

Memory Stick Select

Memory Stick Duo (MS Duo) Memory Stick PRO (MS PRO)

Memory Stick PRO Duo (MS PRO Duo)

Memory Stick PRO-HG Duo

Two additional formats are usable with adapters (not supplied):

MMC Micro

Memory Stick Micro (M2)



Technical Specifications - Optical and Removable Storage

HP DX115 Removable Drive Enclosure

Interface Type Compatible with SAS or SATA controllers

Dimensions (WxHxL) 5.81 x 1.62 x 8.08 in (147.6 x 41.1 x 205 mm)

Weight Frame and Carrier: 3.8 lbs (1.73 kg)

Carrier: 1 lbs (0.45 kg)



Technical Specifications - Controller Cards

HP FireWire/IEEE 1394a Data Transfer Rate
PCI Card Davids Interface Pr

Data Transfer Rate Burst Data Rate up to 400 Mbps

Device Interface Protocol IEEE-1394a

Devices Supported IEEE-1394 compliant devices

Bus Type PCI card with brackets for low profile and full height PCI slots.

Certification Level FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998

STD, Taiwan BSMI CNS13438, Korea MIC

Ports Two IEEE 1394 6-Pin Connector (Rear)

Internal Connectors One 10-Pin (9 Contacts) Custom Connector

System Requirements Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista

Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. No driver is required for this device. Native support is provided

by the operating system.

* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. For Windows Vista system requirements, visit:

http://www.windowsvista.com/systemrequirements.

Pentium II 266 or above

128-MB RAM 1-GB Hard Drive CD-ROM drive Built-in sound system Available PCI slot

Temperature - Operating 50°

50° to 131° F (10° to 55° C) -22° to 140° F (-30° to 60° C)

Relative Humidity -

Temperature - Storage

20% to 80%

Operating

Operating Systems

Supported

Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP

Home 32*

* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. For Windows Vista

system requirements, visit:

http://www.windowsvista.com/systemrequirements.



Technical Specifications - Controller Cards

HP IEEE 1394b FireWire PCle Card

Data Transfer Rate
Supports up to 800 Mbps
Devices Supported
IEEE-1394 compliant devices
Bus Type
PCle card full height PCle slots

Ports Two IEEE-1394b bilingual 9-Pin Connector (Rear)

Internal Connectors One 10-Pin header Custom Connector

System Requirements Microsoft Windows XP Professional, Windows XP Home, Windows Vista. Not

supported on Linux. Pentium® III or higher processor 128-MB RAM 1-GB

Hard Drive CD-ROM drive Built in sound system Available PCI slot

Temperature – Operating 50° to 131° F (10° to 55° C)

Temperature – Storage –22° to 140° F (–30° to 60° C)

Relative Humidity -

Operating

20% to 80%

Compliances FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998

STD, Taiwan BSMI CNS13438, Korea MIC

Operating Systems

Supported

Microsoft Windows XP and Windows Vista



Technical Specifications - Networking and Communications

NOTE 1: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Integrated Broadcom 5764 PCle LOM Controller Connector RJ45

Data Rates Supported 10/100/1000BT

Bus Architecture PCle X1
Alerting ASF 2.0

Broadcom (5761) NetXtreme Gigabit Ethernet Plus NIC Connector RJ-45

Controller Broadcom 5761 PCI-Express LAN Controller

Memory 8 MB NVRAM serial Flash

Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB, 802.3u, and 802.3x

Bus Architecture PCI-Express

Data Path Width Single Channel PCI-Express

Data Transfer Mode Bus Master DMA

Hardware Certifications FCC class B, Canada and US NRTL Mark, C-Tick for Australia, BSMI for

Taiwan, VCCI for Japan, MIC for Korea, GOST for Russia, UL listed

(E212044), European Union Notice (CE 0682)

Power Requirement 1.8W @ 3.3V

Boot ROM Support Yes

Network Transfer Mode Full-duplex

Half-duplex (not available for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature 32° to 131°F (0° to 55° C)

Operating Humidity 131° F (55° C) with 5% to 95% non-condensing humidity

Dimensions 2.75 in x 4.13 in (7 cm x 10.5 cm), low profile compatible

Operating System Driver Windows Vista 32-bit SP1, Windows Vista x64 SP1, Windows XP 32 bit

Support professional, Windows XP x64.

Management Capabilities ACPI, WOL and DMI 2.0, PXE 2.0, WfM 2.0, Broadcom mgmt utility,

ASF2.0, DASH 1.0 and DASH 1.1 profiles

Kit Contents Broadcom NetXtreme Gigabit Ethernet Plus NIC, Broadcom NetXtreme

Gigabit Ethernet Plus NIC USB Cable Assembly, CD, drivers, quick install

guide, product warranty statement

Technical Specifications - Networking and Communications

HP NC360T PCI Express Dual Port Gigabit NIC Connector Two RJ-45
Controller Intel 82571EB
Memory Integrated 96KB
Data Rates Supported 10/100/1000 Mbps

Compliance 802.3, 802.3u, 802.3x, 802.3ab, 802.3ad, 802.1p, 802.1Q

Bus Architecture PCI-E 1.0a

Data Path Width Four lane (x4) PCI Express compatible with x4, x8, and x16 PCI Express slots

Data Transfer Mode Bus-master DMA

Hardware Certifications FCC Class B, VCCI Class B, BSMI Class A, CISPR 22 Class B, EN 55022

Class B, EN55024-1, ICES-003 Class B, MIC Class B, ACA Class B, UL,

Canada UL, EN60950

Power Requirement 1280 mA @ 3.3V typical

Boot ROM Support Yes

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature 32° to 131° F (0° to 55° C) Operating Humidity 0% to 95% non-condensing Dimensions 5.1×2.7 in $(12.95 \times 6.8 \text{ cm})$

Operating System Driver

Support

Windows Vista Business 64*, Windows Vista Business 32*, Windows XP

Professional, Windows XP Professional x64 Edition.

Red Hat Enterprise Linux(RHEL) WS4, 5 Desktop/Workstation

Novell SLES 9 & SLE 10

* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. For Windows Vista

system requirements, visit:

http://www.windowsvista.com/systemrequirements.

Management Capabilities WOL, PXE 2.1

Kit Contents HP NC360T PCI Express Dual Port Gigabit NIC, low profile bracket, CD

containing Intel PROset II NIC drivers, quick install guide, product warranty

statement



Technical Specifications - Networking and Communications

Intel Gigabit CT Desktop Connector

NIC

Connector RJ-45

Controller Intel WG82574L Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB and 802.3u compliant,

802.3x flow control

Bus Architecture PCI-E 1.0a

Data Path Width X1, 250 MB/s, Bi-directional interface

Data Transfer Mode Bus-master DMA

Hardware Certifications FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark

for European Union

Power Requirement Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T

Boot ROM Support Yes

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature 32° to 131° F (0° to 55° C) Operating Humidity 85% at 131° F (55° C)

Dimensions 4.75 x 2.25 x 0.8 in (12.1 x 5.7 x 2.0 cm)

Operating System Driver

Support

Windows Vista Business 64, Windows Vista Business 32, Windows XP

Professional, Windows XP x64.

Red Hat Enterprise Linux 4, Red Hat Enterprise Linux 5.

Management Capabilities WOL , PXE, DMI, WFM 2.0

Kit Contents Intel Gigabit CT Desktop NIC, low profile bracket, CD containing Intel

PROset II NIC drivers, quick install guide, product warranty statement

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